

LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

*EXAMINER	DOCUMENT	DATE	NAME	INT'L	SUB-	FILING DATE
<u>INITIAL</u>	<u>NUMBER</u>			<u>CLASS</u>	<u>CLASS</u>	<u>(If Appropriate)</u>
<u>AA</u>	<u>6,271,040</u>	<u>08/07/01</u>	<u>Buechler</u>	<u>G01N</u>	<u>21/85</u>	<u>07/30/97</u>
<u>AB</u>	<u>6,296,020</u>	<u>10/02/01</u>	<u>McNeely et al.</u>	<u>F15B</u>	<u>21/00</u>	<u>10/13/99</u>

FOREIGN PATENT DOCUMENTS							
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLATION (YES) (NO)	
_____	AC	_____	_____	_____	_____	_____	_____
_____	AD	_____	_____	_____	_____	_____	_____
_____	AE	_____	_____	_____	_____	_____	_____

AF Phillip G. Wapner, et al.; "Utilization of surface tension and wettability in the design and operation of microsensors"; Sensors and Actuators B 71 (2000); pp. 60-67.

AG

EXAMINER

DATE CONSIDERED

JCH - 198 - 111a

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400 SEVENTH STREET, N.W.
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LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

ATTY. DOCKET NO.: P69147US0 GROUP ART UNIT: Not Yet Assigned
SERIAL NO.: New Application FILING DATE: September 29, 2003
APPLICANT(S): Kwang Hyo CHUNG, et al. TODAY'S DATE: September 29, 2003

U.S. PATENT DOCUMENTS

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<u>α</u>	AA 6,271,040	08/07/01	Buechler	G01N	21/85	07/30/97
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OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

α AF Phillip G. Wapner, et al.; "Utilization of surface tension and wettability in the design and operation of microsensors"; Sensors and Actuators B 71 (2000); pp. 60-67.

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EXAMINER

DATE CONSIDERED

α 10/2/03

* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).